

Features

- On-Resistance: 0.8Ω (TYP)
- -3dB Bandwidth: 80MHz
- Single-Supply Operation: +1.8V ~ +5.5V
- Break-Before-Make Switching
- Rail-to-Rail Operation
- Low Static Power
- TTL/CMOS Compatible
- Operating Temperature: -40°C ~ +125°C
- Small Package:
GS3005 Available in TDFN-3x3-10L and MSOP-10 Packages

General Description

The GS3005 is low on-resistance (0.8Ω), fast single-pole double-throw (SPDT) CMOS switch with operation range +1.8V ~ +5.5V. The GS3005 is designed for low operating voltage, high current switching of signal gating, chopping, modulation or demodulation (modem), and speaker output for cell phone applications.

The device contains a break-before-make (BBM) feature. The control input, IN, tolerates input drive signals up to 5.5V, independent of supply voltage.

All devices are specified for the temperature range of -40°C to +125°C. The GS3005 Dual is available in Green TDFN-3X3-10L and MSOP-10 packages.

Applications

- Battery-Operated Equipment
- Wearable Devices
- Computer Peripherals
- Portable Systems
- Cell Phones
- PDAs

Pin Configuration

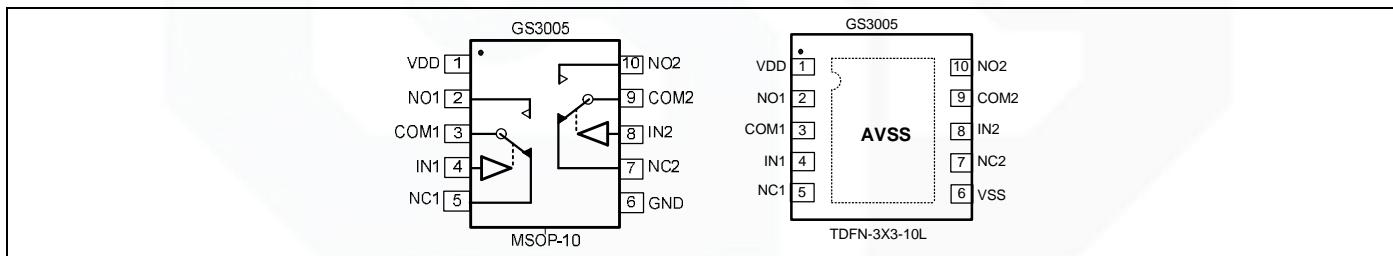


Figure 1. Pin Assignment Diagram

Absolute Maximum Ratings

Condition	Min	Max
Power Supply Voltage (V_{DD} to V_{SS})	-0.5V	+7.5V
Analog Input Voltage (NC NO or COM)	$V_{SS}-0.5V$	$V_{DD}+0.5V$
PDB Input Voltage	$V_{SS}-0.5V$	+7V
Operating Temperature Range	-40°C	+125°C
Junction Temperature	+160°C	
Storage Temperature Range	-55°C	+150°C
Lead Temperature (soldering, 10sec)	+260°C	
Package Thermal Resistance ($T_A=+25^\circ C$)		
MSOP-10, θ_{JA}	216°C/W	
ESD Susceptibility		
HBM	3500V	
MM	300V	

Note: Stress greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Package/Ordering Information

MODEL	CHANNEL	ORDER NUMBER	PACKAGE DESCRIPTION	PACKAGE OPTION	MARKING INFORMATION
GS3005	Dual	GS3005-FR	TDFN-3X3-10L	Tape and Reel,3000	GS3005
		GS3005-MR	MSOP-10	Tape and Reel,3000	GS3005

Electrical Characteristics

(At $V_S = +5V$, and $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS				
			TYP	MIN	MAX	UNITS
ANALOG SWITCH						
Analog Signal Range	V_{NO}, V_{NC}, V_{COM}		0	V_S	V	
On-Resistance	R_{ON}	$V_S = 4.5V, V_{NO} \text{ or } V_{NC} = 3.5V, I_{COM} = -10mA$, Test Circuit 1	0.8			Ω
		$V_S = 2.7V, V_{NO} \text{ or } V_{NC} = 1.5V, I_{COM} = -10mA$, Test Circuit 1	1.9			Ω
On-Resistance Match Between Channels	ΔR_{ON}	$V_S = 4.5V, V_{NO} \text{ or } V_{NC} = 3.5V, I_{COM} = -10mA$, Test Circuit 1	0.43		0.47	Ω
		$V_S = 2.7V, V_{NO} \text{ or } V_{NC} = 1.5V, I_{COM} = -10mA$, Test Circuit 1	0.45		0.5	Ω
On-Resistance Flatness	$R_{FLAT(ON)}$	$V_S = 4.5V, V_{NO} \text{ or } V_{NC} = 1.0V, 2.0V, 3.5V, I_{COM} = -10mA$, Test Circuit 1	0.2		0.3	Ω
		$V_S = 2.7V, V_{NO} \text{ or } V_{NC} = 1.0V, 1.5V, 2.0V, I_{COM} = -10mA$, Test Circuit 1	0.2		0.35	Ω
Source OFF Leakage Current	$I_{NC(OFF)}, I_{NO(OFF)}$	$V_S = 5.5V, V_{NO} \text{ or } V_{NC} = 1.0V, 4.5V, V_{COM} = 4.5V, 1.0V$			1	μA
Channel ON Leakage Current	$I_{NC(ON)}, I_{NO(ON)}, I_{COM(ON)}$	$V_S = 5.5V, V_{COM} = 1.0V, 4.5V V_{NO} \text{ or } V_{NC} = 1.0V, 4.5V, \text{or floating}$			1	μA
DIGITAL INPUTS						
Input High Voltage	V_{INH}	$V_S = 5V$	1.5			V
		$V_S = 3V$	0.9			V
Input Low Voltage	V_{INL}	$V_S = 5V$		0.55		V
		$V_S = 3V$		0.45		V
Input Leakage Current	I_{IN}	$V_S = 5.5V, V_{IN} = 0V \text{ or } 5.5V$			1	μA

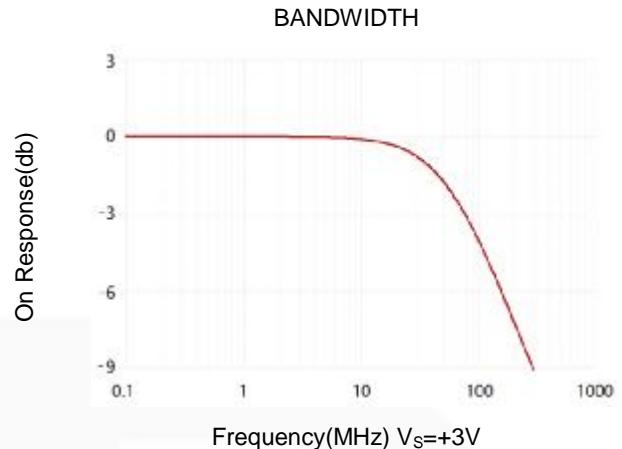
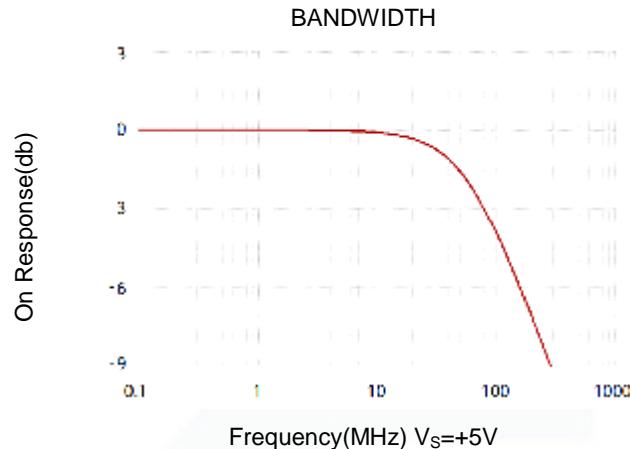
Electrical Characteristics

(At $V_S = +5V$, and $T_A = +25^\circ C$, unless otherwise noted.)

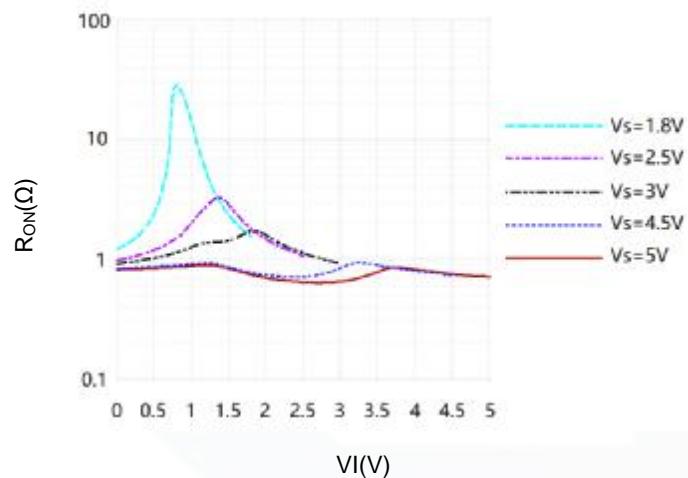
PARAMETER	SYMBOL	CONDITIONS				
			TYP	MIN	MAX	UNITS
DYNAMIC CHARACTERISTICS						
Turn-On Time	T_{ON}	$V_S = 5V, V_{NO} \text{ or } V_{NC} = 3V, V_{IN_H} = 1.5V, V_{IN_L} = 0V, R_L = 300\Omega, C_L = 35pF, \text{ Test Circuit 2}$	20			ns
		$V_S = 3V, V_{NO} \text{ or } V_{NC} = 1.5V, V_{IN_H} = 1.5V, V_{IN_L} = 0V, R_L = 300\Omega, C_L = 35pF, \text{ Test Circuit 2}$	28			ns
Turn-Off Time	T_{OFF}	$V_S = 5V, V_{NO} \text{ or } V_{NC} = 3V, V_{IN_H} = 1.5V, V_{IN_L} = 0V, R_L = 300\Omega, C_L = 35pF, \text{ Test Circuit 2}$	23			ns
		$V_S = 3V, V_{NO} \text{ or } V_{NC} = 1.5V, V_{IN_H} = 1.5V, V_{IN_L} = 0V, R_L = 300\Omega, C_L = 35pF, \text{ Test Circuit 2}$	22			ns
Break-Before-Make Time Delay	T_{BBM}	$V_S = 5V, V_{NO1} \text{ or } V_{NC1} = V_{NO2} \text{ or } V_{NC2} = 3V, R_L = 300\Omega, C_L = 35pF, \text{ Test Circuit 3}$	23			ns
		$V_S = 3V, V_{NO1} \text{ or } V_{NC1} = V_{NO2} \text{ or } V_{NC2} = 3V, R_L = 300\Omega, C_L = 35pF, \text{ Test Circuit 3}$	27			ns
Skew	T_{SKEW}	$V_S = 5V, R_S = 39\Omega, C_L = 50pF, \text{ Test Circuit 4}$	9			ns
		$V_S = 3V, R_S = 39\Omega, C_L = 50pF, \text{ Test Circuit 4}$	9			ns
Off Isolation	O_{ISO}	$R_L = 50\Omega, \text{ Signal} = 0dBm, C_L = 5pF, \text{ Test Circuit 5}$	f=10MHz	-40		db
			f=1MHz	-60		db
-3dB Bandwidth	BW	$R_L = 50\Omega, \text{ Signal} = 0dBm, C_L = 5pF, \text{ Test Circuit 6}$	80			MHz
Source OFF Capacitance	$C_{NC(OFF)}, C_{NO(OFF)}$	f=1MHz	20			pF
Channel ON Capacitance	$C_{NC(ON)}, C_{NO(ON)}, C_{COM(ON)}$	f=1MHz	73			pF
POWER REQUIREMENTS						
Power Supply Range	V_S			1.8	5.5	V
Power Supply Current	I_S	$V_{IN} = 0V \text{ or } V_S$			1	μA

Typical Performance characteristics

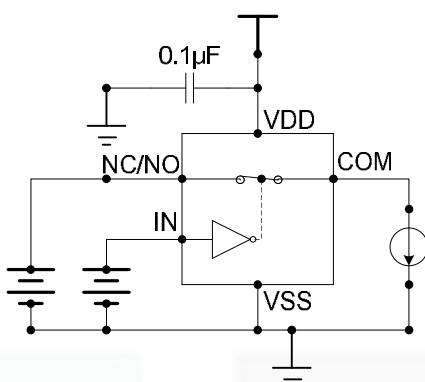
At $T_A=+25^\circ\text{C}$, and $V_S=+5\text{V}$, unless otherwise noted.



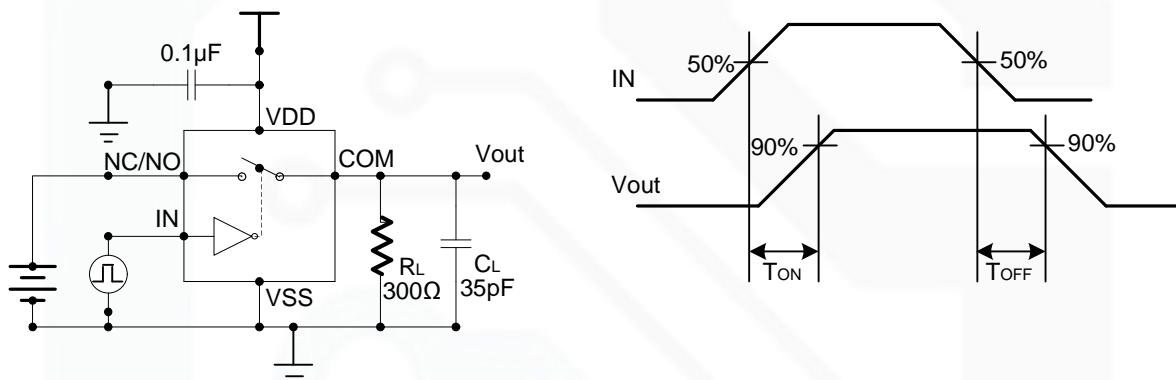
Typical R_{ON} vs Input Voltage (VI)



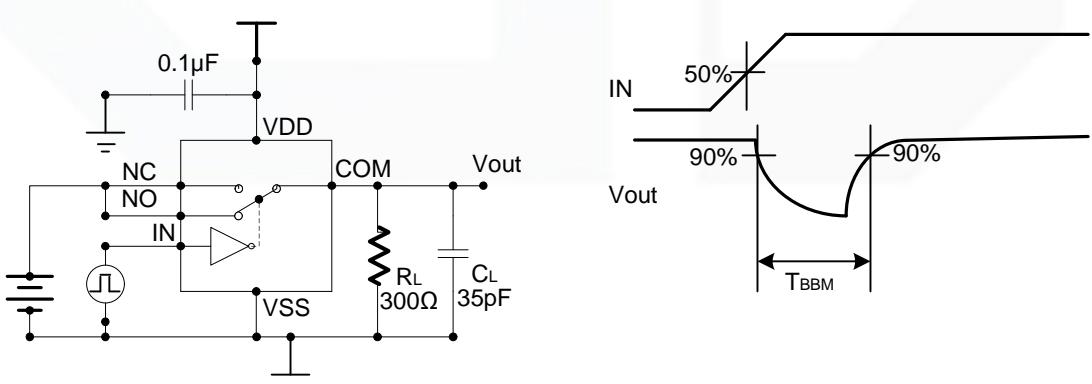
Parameter Measurement Information



Test Circuit 1. On-Resistance

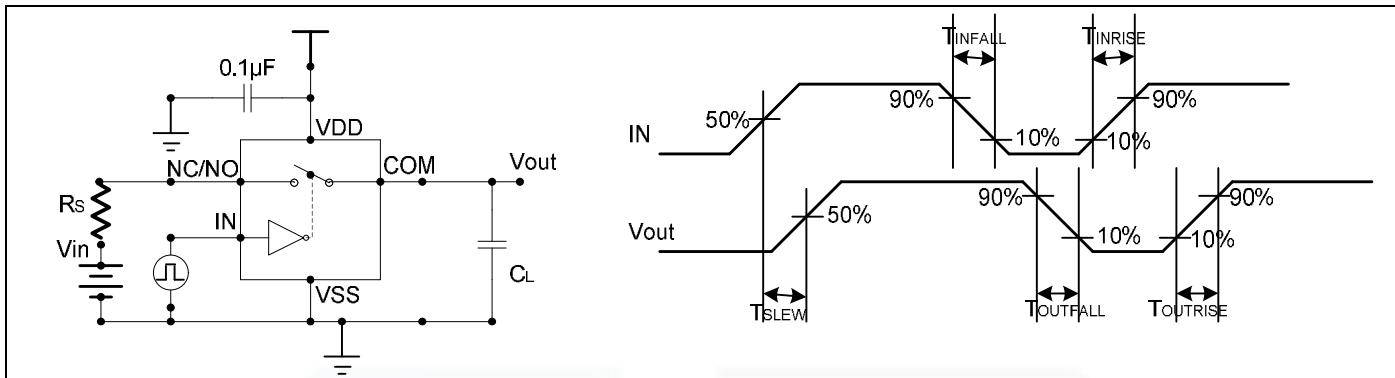


Test Circuit 2. Switching Times

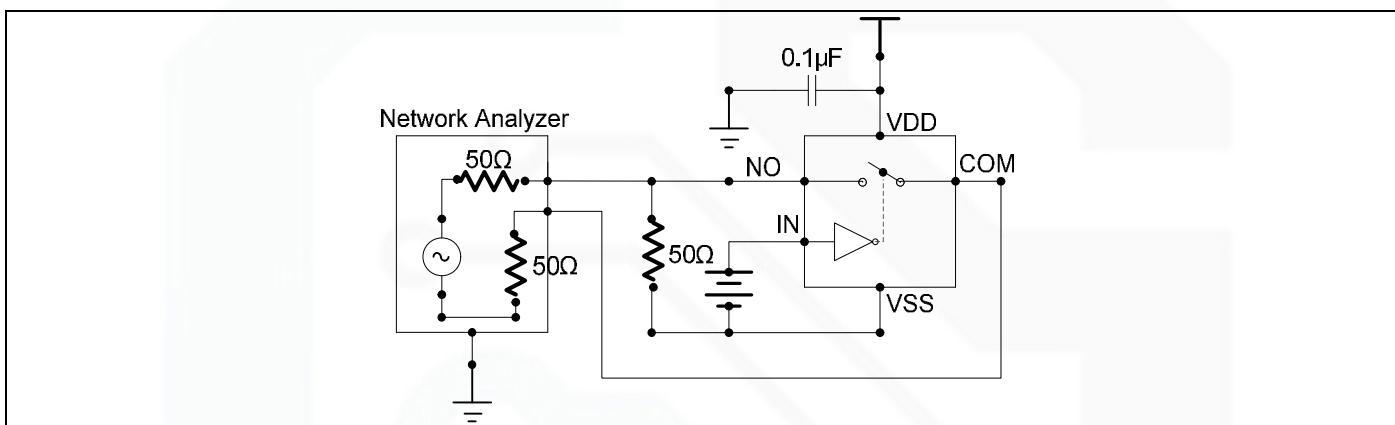


Test Circuit 3. Break-Before-Make Time Delay

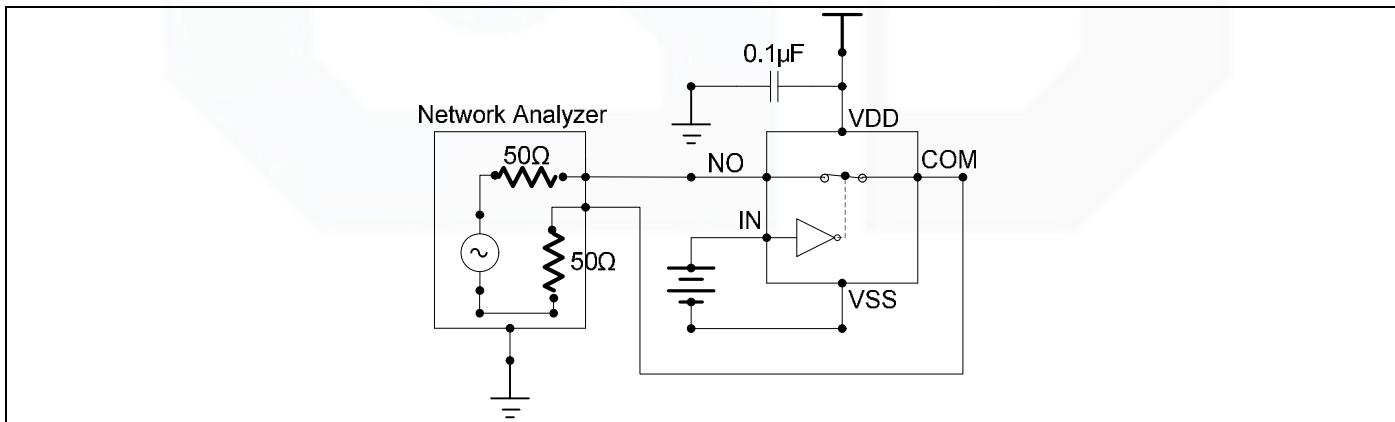
Parameter Measurement Information



Test Circuit 4. Output Signal Skew



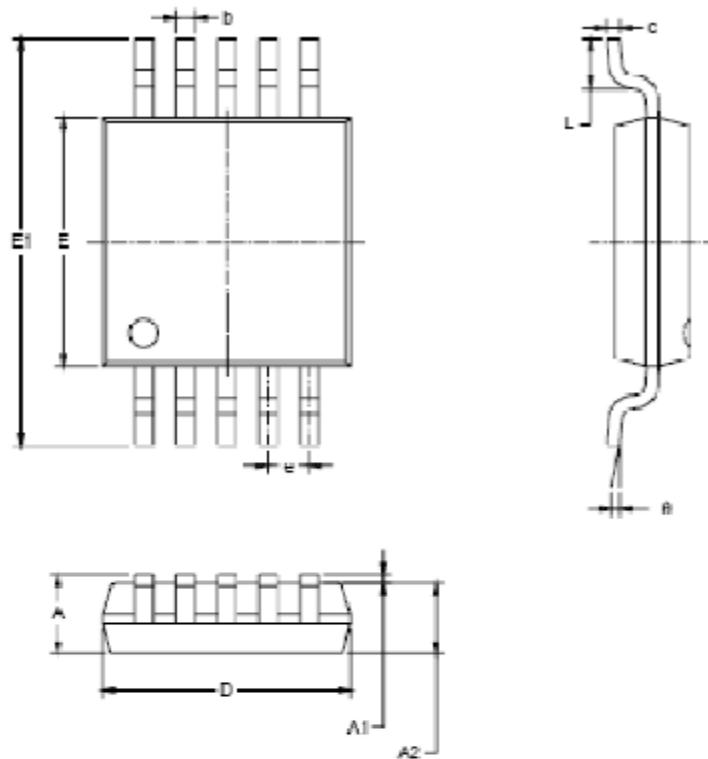
Test Circuit 5. Off Isolation



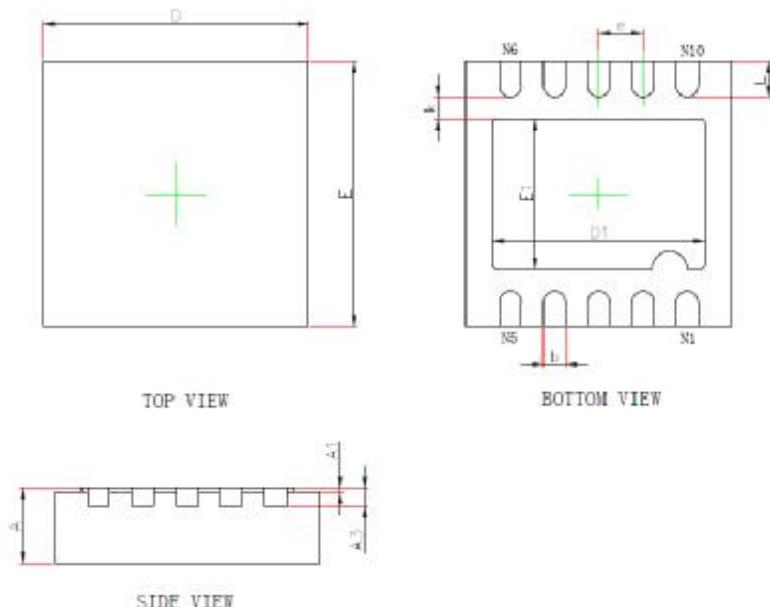
Test Circuit 6. -3dB Bandwidth

Package Information

MSOP-10



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.005
A2	0.750	0.950	0.030	0.037
b	0.180	0.280	0.007	0.011
c	0.080	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
E	2.000	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
e	0.500 BSC		0.020 BSC	
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

TDFN-3X3-10L


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700/0.800	0.800/0.900	0.028/0.031	0.031/0.035
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	2.924	3.076	0.115	0.121
E	2.924	3.076	0.115	0.121
D1	2.300	2.500	0.091	0.098
E1	1.600	1.800	0.063	0.071
k	0.200MIN.		0.008MIN.	
b	0.200	0.300	0.008	0.012
e	0.500TYP.		0.020TYP.	
L	0.324	0.476	0.013	0.019